MB39C605

ASSP Phase Dimmable PSR LED Driver IC for LED Lighting Data Sheet (Full Production)



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MB39C605

ASSP



Phase Dimmable PSR LED Driver IC for LED Lighting

Data Sheet (Full Production)

1. Description

MB39C605 is a PSR (Primary Side Regulation) LED driver IC for LED lighting. Using the information of the primary peak current and the transformer-energy-zero time, it is able to deliver a well regulated current to the secondary side without using an opto-coupler in an isolated flyback topology. Operating in critical conduction mode, smaller transformer is required. In addition, MB39C605 has a built-in phase dimmable circuit and can constitute the lighting system for phase dimming.

It is most suitable for the general lighting applications, for example replacement of commercial and residential incandescent lamps.

2. Features

- PSR topology in an isolated flyback circuit
- High efficiency (>80% : without dimmer) and low EMI by detecting transformer zero energy
- TRAIC Dimmable LED lighting
- Highly reliable protection functions
 - Under voltage lock out (UVLO)
 - Over voltage protection (OVP)
 - Over current protection (OCP)
 - Short circuit protection (SCP)
 - Over temperature protection (OTP)
- Switching frequency setting : 30kHz to 133kHz
- Input voltage range VDD : 9V to 20V
- Input voltage for LED lighting applications : AC110V_{RMS}, AC230V_{RMS}
- Output power range for LED lighting applications : 5W to 10W
- Small Package : SOP-8 (3.9mm × 5.05mm × 1.75mm[Max])

3. Applications

- Phase dimmable (Leading/Trailing) LED lighting
- LED lighting

m asy DesignSim

Online Design Simulation Easy DesignSim

This product supports the web-based design simulation tool. It can easily select external components and can display useful information. Please access from the following URL. http://www.spansion.com/easydesignsim/

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4. Pin Assignment



5. Pin Descriptions

Table 5-1 Pin Descriptions

Pin No.	Pin Name	I/O	Description
1	VDD	-	Power supply pin.
2	TZE	I	Transformer Zero Energy detecting pin.
3	COMP	0	External Capacitor connection pin for the compensation.
4	VAC	I	Phase dimming control pin.
5	ADJ	0	Pin for adjusting the switch-on timing.
6	CS	I	Pin for detecting peak current of transformer primary winding.
7	GND	-	Ground pin.
8	DRV	0	External MOSFET gate connection pin.



6. Block Diagram



Figure 6-1 Block Diagram (Isolated Flyback application)



7. Absolute Maximum Ratings

			Rat	ing	
Parameter	Symbol	Condition	Min	Max	Unit
Power Supply Voltage	V _{VDD}	VDD pin	-0.3	+25	V
	V _{CS}	CS pin	-0.3	+6.0	V
Input Voltage	V _{TZE}	TZE pin	-0.3	+6.0	V
	V _{VAC}	VAC pin	-0.3	+6.0	V
Output Voltage	V _{DRV}	DRV pin	-0.3	+25	V
	I _{ADJ}	ADJ pin	-1	-	mA
Output Current	I _{DRV}	DRV pin DC level	-50	+50	mA
Power Dissipation	P _D	Ta≤ +25°C	-	800 (*1)	mW
Storage temperature	T _{STG}	-	-55	+125	°C
ESD Voltage 1	V _{ESDH}	Human Body Model	-2000	+2000	V
ESD Voltage 2	V _{ESDM}	Machine Model	-200	+180	V
ESD Voltage 3	V _{ESDC}	Charged Device Model	-1000	+1000	V

Table 7-1 Absolute Maximum Rating

*1: The value when using two layers PCB.

Reference: 0ja (wind speed 0m/s): +125°C/W





WARNING:

1. Semiconductor devices may be permanently damaged by application of stress (including, without limitation, voltage, current or temperature) in excess of absolute maximum ratings. Do not exceed any of these ratings.



o. Recommended Operating Conditions	8.	Recommended	Operating	Conditions
-------------------------------------	----	-------------	-----------	------------

Paramatar	Symbol	Condition		Unit				
Farameter	Symbol	Condition	Min Typ Max		onit			
VDD pin Input Voltage	VDD	VDD pin	9	-	20	V		
VAC pin Input Voltage	V _{VAC}	VAC pin After UVLO release	0	-	5	V		
VAC pin Input Current	I _{VAC}	VAC pin Before UVLO release	0	-	2.5	μA		
TZE pin Resistance	R _{TZE}	TZE pin	50	-	200	kΩ		
ADJ pin Resistance	R _{ADJ}	ADJ pin	9.3	-	185.5	kΩ		
COMP pin Capacitance	C _{COMP}	COMP pin	-	0.01	-	μF		
VDD pin Capacitance	C _{BP}	Set between VDD pin and GND pin	-	4.7	-	μF		
Operating Junction Temperature	Tj	-	-40	-	+125	°C		

Table 8-1 Recommended Operating Conditions

WARNING:

- 1. The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated under these conditions.
- 2. Any use of semiconductor devices will be under their recommended operating condition.
- 3. Operation under any conditions other than these conditions may adversely affect reliability of device and could result in device failure.
- 4. No warranty is made with respect to any use, operating conditions or combinations not represented on this data sheet. If you are considering application under any conditions other than listed herein, please contact sales representatives beforehand.



9. Electrical Characteristics

Table 9-1 Electrical Characteristics

(Та	=	+25°	°C.	Vvdd	=	12V)
	ιu		. 20	Ο,			12.0	,

Parameter		Symbol Din				Value		Unit
		Symbol	Pin	Condition	Min	Тур	Max	Unit
POWER SUPPLY		I _{VDD(STATIC)}	VDD	V_{VDD} =20V, V_{TZE} =1V	-	3	3.6	mA
CURRENT	Power supply current	Ivdd(operating)	VDD	V _{VDD} =20V, Qg=20nC, f _{SW} =133kHz	-	5.6	-	mA
	UVLO Turn-on threshold voltage	V _{TH}	VDD	-	12.25	13	13.75	v
UVLO	UVLO Turn-off threshold voltage	V _{TL}	VDD	-	7.55	7.9	8.5	v
	Startup current	I _{START}	VDD	V _{VDD} =7V	-	65	160	μΑ
	Zero energy threshold voltage	V _{TZETL}	TZE	TZE="H" to "L"	-	20	-	mV
	Zero energy threshold voltage	V _{TZETH}	TZE	TZE="L" to "H"	0.6	0.7	0.8	v
	TZE clamp voltage	V _{TZECLAMP}	TZE	Ι _{τze} =-10μΑ	-200	-160	-100	mV
DETECTION	OVP threshold voltage	V _{TZEOVP}	TZE	-	4.15	4.3	4.45	v
	OVP blanking time	t _{ovpblank}	TZE	-	0.6	1	1.7	μs
	TZE input current	I _{TZE}	TZE	V _{TZE} =5V	-1	-	+1	μA
COMPENSATION	Source current	I _{SO}	COMP	V_{COMP} =2V, V_{CS} =0V V_{VAC} =1.85V	-	-27	-	μA
	Trans conductance	gm	COMP	V _{COMP} =2.5V, V _{CS} =1V	-	96	-	μΑ/ν
	VAC input current	IVAC	VAC	V _{VAC} =5V	-0.1	-	+0.1	μΑ
DIMMING	VACCMP threshold voltage	V _{VACCMPVTH}	VAC	-	135	150	165	mV
	VACCMP hysteresis	VVACCMPHYS	VAC	-	-	70	-	mV
	ADJ voltage	V _{ADJ}	ADJ	-	1.81	1.85	1.89	v
	ADJ source current	I _{ADJ}	ADJ	V _{ADJ} =0V	-650	-450	-250	μA
ADJUSIMENI	ADJ time	T _{ADJ}	TZE DRV	T _{ADJ} (R _{ADJ} =51kΩ) - T _{ADJ} (R _{ADJ} =9.1kΩ)	490	550	610	ns
	Minimum switching period	T _{sw}	TZE DRV	-	6.75	7.5	8.25	μs



(Ta = +25°	С,	V_{VDD}	=	12V)
------------	----	-----------	---	------

Parameter		Sumbol	Din	Condition		Unit		
Fa	arameter	Symbol	Pin	Condition	Min	Тур	Max	Unit
	OCP threshold voltage	V _{OCPTH}	CS	-	1.9	2	2.1	v
CURRENT SENSE	OCP delay time	t _{OCPDLY}	CS	-	-	400	500	ns
	CS input current	I _{CS}	CS	V _{CS} =5V	-1	-	+1	μA
	DRV high voltage	V _{DRVH}	DRV	VDD=18V, I _{DRV} =-30mA	7.6	9.4	-	v
	DRV low voltage	V _{DRVL}	DRV	VDD=18V, I _{DRV} =30mA	-	130	260	mV
	Rise time	t _{RISE}	DRV	VDD=18V, CLOAD=1nF	-	94	-	ns
	Fall time	t _{FALL}	DRV	VDD=18V, CLOAD=1nF	-	16	-	ns
DRV	Minimum on time	t _{onmin}	DRV	TZE trigger	300	500	700	ns
	Maximum on time	t _{onmax}	DRV	-	27	44	60	μs
	Minimum off time	toffmin	DRV	-	1	1.5	1.93	μs
	Maximum off time	t _{offmax}	DRV	TZE=GND	270	320	370	μs
OTD	OTP threshold	T _{OTP}	-	Tj, temperature rising	-	+150	-	°C
	OTP hysteresis	T _{OTPHYS}	-	Tj, temperature falling, degrees below T _{OTP}	-	+25	-	°C



10. Standard Characteristics



Figure 10-1 Standard Characteristics





11. Function Explanations

11.1 LED Current Control by PSR (Primary Side Regulation)

MB39C605 regulates the average LED current (I_{LED}) by feeding back the information based on Primary Winding peak current (I_{P_PEAK}) and Secondary Winding energy discharge time (T_{DIS}) and switching period (T_{SW}). Figure 11-1 shows the operating waveform in steady state. I_P is Primary Winding current and I_S is Secondary Winding current. I_{LED} as an average current of the Secondary Winding is described by the following equation.

$$I_{\text{LED}} = \frac{1}{2} \times I_{\text{S}_{\text{PEAK}}} \times \frac{\text{T}_{\text{DIS}}}{\text{T}_{\text{SW}}}$$

Using I_{P_PEAK} and the transformer Secondary to Primary turns ratio (N_P/N_S), Secondary Winding peak current (I_{S_PEAK}) is described by the following equation.

$$I_{S_PEAK} = \frac{N_P}{N_S} \times I_{P_PEAK}$$

Therefore,

$$I_{LED} = \frac{1}{2} \times \frac{N_{P}}{N_{S}} \times I_{P_PEAK} \times \frac{T_{DIS}}{T_{SW}}$$

MB39C605 detects T_{DIS} by monitoring TZE pin and I_{P_PEAK} by monitoring CS pin. An internal Err Amp sinks gm current proportional to I_{P_PEAK} from COMP pin during T_{DIS} piriod. In steady state, since the average of the gm current is equal to internal referense current (I_{SO}), the voltage on COMP pin (V_{COMP}) is nearly constant.

$$I_{P_PEAK} \times R_{CS} \times gm \times T_{DIS} = I_{SO} \times T_{SW}$$

In above equation, gm is transconductance of the Err Amp and R_{CS} is a sence resistance. Eventually, I_{LED} can be calculated by the following equation.

$$I_{\text{LED}} = \frac{1}{2} \times \frac{N_{\text{P}}}{N_{\text{s}}} \times \frac{I_{\text{so}}}{gm} \times \frac{1}{R_{\text{cs}}}$$

Figure 11-1 LED Current Control Waveform





11.2 Dimming Function

MB39C605 has the built-in Phase dimmable circuit to control I_{LED} by changing a reference of Err Amp based on the input dimming control level on the VAC pin and realizes dimming. Figure 11-2 shows the input circuit to the VAC pin for phase dimming. V_{BULK0} is divided and filtered into an analog voltage with RC network. It is possible to configurate phase dimmable system by inputting the voltage to the VAC pin.

Figure 11-2 VAC Pin Input Circuit





11.3 Power-On Sequence

When the AC line voltage is supplied, V_{BULK} is powered from the AC line through a diode bridge and a diode (D1) with charging a capacitor (C_{BULK}), and the VDD pin is charged from V_{BULK} through a start-up resistance (Rst). (Figure 11-3 red path)

When the VDD pin is charged up and the voltage on the VDD pin (V_{VDD}) rises above the UVLO threshold voltage, an internal Bias circuit starts operating, and MB39C605 starts the dimming control. After the UVLO is released, this device enables switching and is operating in a forced switching mode (T_{ON} =1.5µs, T_{OFF} =78µs to 320µs). When the voltage on the TZE pin reaches the Zero energy threshold voltage (V_{TZETH} =0.7V), MB39C605 enters normal operation mode. After the switching begins, the VDD pin is also charged from Auxiliary Winding through an external diode (DBIAS).(Figure 11-3 blue path)

During start-up period V_{VDD} is not supplied from Auxiliary Winding, because the LED voltage is low. V_{VDD} decreases gradually until the LED voltage rises enogh high that the Auxiliary Winding voltage can exceed V_{VDD}. In this period, if V_{VDD} falls bellow the UVLO threshold voltage, the switching stops. When the VDD pin is charged up again and V_{VDD} rises above the UVLO threshold voltage, MB39C605 restarts the switching. This device repeats above operation until the LED voltage rises enogh high. V_{VDD} becomes stabel after that.



Figure 11-3 VDD Supply Path at Power-On

Figure 11-4 Power-On Waveform



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11.4 Power-Off Sequence

After the AC line voltage is removed, V_{BULK} is discharged by switching operation. Since any Secondary Winding current does not flow, I_{LED} is supplied only from output capacitors and decreases gradually. V_{VDD} also decreases because there is no current supply from both Auxiliary Winding and V_{BULK} . When V_{VDD} falls below the UVLO threshold voltage, MB39C605 shuts down.





11.5 IP_PEAK Detection Function

MB39C605 detects Primary Winding peak current (I_{P_PEAK}) of Transformer. I_{LED} is set by connecting a sence resistance (Rcs) between CS pin and GND pin. Maximum I_{P_PEAK} ($I_{P_PEAKMAX}$) limited by Over Current Protection (OCP) can also be set with the resistance.

Using the Secondary to Primary turns ratio (N_P/N_S) and I_{LED} , R_{CS} is set as the following equation (refer to 11.1)

$$R_{CS} = \frac{N_{P}}{N_{S}} \times \frac{0.14}{I_{LED}}$$

In addition, using the OCP threshold voltage (V_{OCPTH}) and R_{CS} , $I_{P_PEAKMAX}$ is caluculated with the following equation.

$$I_{P_{PEAKMAX}} = \frac{V_{OCPTH}}{R_{CS}}$$

11.6 Zero Voltage Switching Function

MB39C605 has built-in zero voltage switching function to minimize switching loss of the external switching MOSFET. This device detects a zero crossing point through a resistor divider connected from TZE pin to Auxiliary Winding. A zero energy detection circuit detects a negative crossing point of the voltage on TZE pin to Zero energy threshold voltage (V_{TZETL}). On-timing of switching MOSFET is decided with waitting an adjustment time (t_{ADJ}) after the negative crossing occurs.

 t_{ADJ} is set by connecting an external resistance (R_{ADJ}) between ADJ pin and GND pin. Using Primary Winding inductance (L_P) and the parasitic drain capacitor of switching MOSFET (C_D), t_{ADJ} is caluculated with the following equation.

$$t_{\rm ADJ} = \frac{\pi \sqrt{L_{\rm P} \times C_{\rm D}}}{2}$$

Using $t_{ADJ},\,R_{ADJ}$ is expressed by the following calculation. $R_{ADJ}\,[k\Omega]$ = 0.0927 × $t_{ADJ}\,[ns]$



11.7 Protection Functions

Under Voltage Lockout Protection (UVLO)

The under voltage lockout protection (UVLO) prevents IC from a malfunction in the transient state during V_{VDD} startup and a malfunction caused by a momentary drop of V_{VDD} , and protects the system from destruction/deterioration. An UVLO comparator detects the voltage decrease below the UVLO threshold voltage on VDD pin, and then DRV pin is turned to "L" and the switching stops. MB39C605 automatically returns to normal operation mode when V_{VDD} increases above the UVLO threshold voltage.

Over Voltage Protection (OVP)

The over voltage protection (OVP) protects Secondary side components from an excessive voltage stress. If the LED is disconnected, the output voltage of Secondary Winding rises up. The output overvoltage can be detected by monitoring TZE pin. During Secondary Winding energy discharge time, V_{TZE} is proportional to V_{AUX} and the voltage of Secondary Winding (refer to 11.1). When V_{TZE} rises higher than the OVP threshold voltage for 3 continues switching cycles, DRV pin is turned to "L", and the switching stops (latch off). When V_{VDD} drops below the UVLO threshold voltage, the latch is removed.

Over Current Protection (OCP)

The over current protection (OCP) prevents inductor or transformer from saturation. The drain current of the external switching MOSFET is limited by OCP. When the voltage on CS pin reaches the OCP threshold voltage, DRV pin is turned to "L" and the switching cycle ends. After zero crossing is detected on TZE pin again, DRV pin is turned to "H" and the next switching cycle begins.

Short Circuit Protection (SCP)

The short circuit protection (SCP) protects the transformer and the Secondary side diode from an excessive current stress. When the short circuit between LED terminals occurs, output voltage decreases. If the voltage on TZE pin falls below SCP threshold voltage, V_{COMP} is discharged and fixed at 1.5V and then the switching enters a low frequency mode.(T_{ON} =1.5 μ s / T_{OFF} =78 μ s to 320 μ s)

Over Temperature Protection (OTP)

The over temperature protection (OTP) protects IC from thermal destruction. When the junction temperature reaches +150°C, DRV pin is turned to "L", and the switching stops. It automatically returns to normal operation mode if the junction temperature falls back below +125°C.

Function	DRV	COMP	ADJ	Detection Condition	Return Condition	Remarks
Normal Operation	Active	Active	Active	-	-	-
Under Voltage Lockout Protection (UVLO)	L	L	L	VDD < 7.9V	VDD > 13V	Auto Restart
Over Voltage Protection (OVP)	L	1.5V fixed	Active	TZE > 4.3V	VDD < 7.9V → VDD > 13V	Latch off
Over Current Protection (OCP)	L	Active	Active	CS > 2V	Cycle by cycle	Auto Restart
Short Circuit Protection (SCP)	Active	1.5V fixed	Active	TZE (peak) < 0.7V	TZE (peak) > 0.7V	Auto Restart
Over Temperature Protection (OTP)	L	1.5V fixed	Active	Tj > +150°C	Tj < +125°C	Auto Restart

Table	11-1	Protection	Functions	Table
				10010



12. I/O Pin Equivalent Circuit Diagram



Figure 12-1 I/O Pin Equivalent Circuit Diagram







13. Application Examples

5W Non-isolated Dimming Application

Input: AC90V_{RMS}~110V_{RMS}, Output: 70mA/70V~76V







Table 13-1 5W BOM List

1M1LED driver (SDP-8M830065Spanior2U1Op-Arp, Low voltage Raik-Scal, 13(JuA, SOT-23-LMX321T3T10Tandomer, Lp-55(JuL Np,Na=150/35)EE80-401MosFET NCH 600 V.28.1 PAKFOUSNBOCFairchild502.0MosFET NCH 600 V.3 AT-02PON NBOCFairchild6B11Bidge Redifiers, 0.5A, 600 V, SOIC-4MB6SFairchild7BR1Bidge Redifiers, 0.5A, 600 V, SOIC-4MB52X489Fairchild8201, ZD2Diode, Zamer, 51 V, 500 W, SOD-123MM52X489Fairchild10D1.02Diode, Samer, 51 V, 500 W, SOD-123MM52X69Fairchild11D3Diode, Zamer, 51 V, 500 W, SOD-123MM52X69Fairchild12Diode, Samer, 51 V, 500 W, SOD-123MM52X69Fairchild13F1.02Diode, Samer, 51 V, 500 W, SOD-123MM52X69Fairchild14D.04Diode, Zamer, 51 V, 500 W, SOD-123MM51065Fairchild15CD3Diode, Samer, 51 V, 500 W, SOD-123MM51065Samer, 500 W, SOD M, SOD-12316D14Capaclor Caramic 2.0/ F30 V 603Samer, 500 W, SOD M, S	No.	COMPONENT	DESCRIPTION	PART No. VENDOR	
1U1Op-Amp. Low voltage Rail-to-Rail 130µA. SOT 23-5LMV321TI3T1Tanaformer, Lp-950µH. Np/Na+150/35EE608Painchil4Q1MosFET N-CH 6002 2.8.1-PAKFOUSNOCCFainchil5Q2MosFET N-CH 6002 3.8.1-PAKFOUSNOCCFainchil6Q3MosFET N-CH 6002 3.8.1-PAKFOUSNOCCFainchil7BR1Bridge Rectifiers, OSA, 6007, SOL-24MMS2548BFainchil9Z03Diode, Zener, 51.V. 500mV, SOL-123MMS2489Fainchil9Diode, Zener, 51.V. 500mV, SOL-123MMS1405Fainchil10D1,D2Diode, Zener, 51.V. 500mV, SOL-123MMS1405On semiconductor11D3Diode, Conne, 200V, SOL-23MMS1405On semiconductor12D4PNP Bioplar Transistor 12V 3A CPH3CPH3106On semiconductor13F1Fuse, chip, AA, ACICC 129V, 1206S100035.01Schurer Inc14C1Capaetor Ceramic 4.2.µF 400V 48.0.4.10200LERRMEFCAMmural15C2Capaetor Ceramic 4.0.µF 50V 603GCM 2.1.Maral16C3Capaetor Ceramic 4.0.µF 50V 603GCM 2.1.Maral17C4.C7Capaetor Ceramic 0.1µF 50V 603GCM 2.1.Maral18R1Resistor, chip, 20KU, 140W, 603GCM 2.1.GCM 2.1.19R2R4Resistor, chip, 20KU, 140W, 603GCM 2.1.GCM 2.1.19R1Resistor, chip, 30KU, 110W, 603GCM 2.1.GCM 2.1.GCM 2.1.<	1	M1	LED driver IC SOP-8	MB39C605 Spansion	
311Transformer. Lpr.550µH. NpNa=150/35EE008EE008Image of the second	2	U1	Op-Amp, Low voltage Rail-to-Rail, 130µA, SOT-23-5	LMV321	ТІ
4 01 MosFET N-CH 600V 2.8A I-PAK FQU5N60C Fairchild 5 02 MosFET N-CH 60V 115m SCT-23 2N7002 Fairchild 6 03 MosFET N-CH 60V 0.8 A TO-92 FON1160C Fairchild 7 BR1 Bridge Redifiers, 0.5A, 600V, SOIC-4 MB6S Fairchild 8 ZD1, ZD2 Diode, Zener, 18V, 500mW, SOD-123 MMSZ52488 Fairchild 9 ZD3 Diode, Zener, 51V, 500mW, SOD-123 MMSZ4689 Fairchild 10 D1, D2 Diode, Eatrentiffer, 1A, 400V, SMA ESTG Fairchild 11 D3 Diode, 20mA, 200V, SOT-23 MMBD1405 Fairchild 12 D4 PNE Bipolar Transistor 12V 3A CPH3 CPH3106 On semiconductor 13 F1 Fuse, chip, 2A, AC/DC12V1206 3410003501 Schutter Inc 14 C1 Capacitor Caramic 0.197 SDV 0603 - - - 16 C3 Capacitor Caramic 0.197 SDV 0603 - - - 17 C4, C7 Capacitor Caramic 0.197 SDV 0603 <td>3</td> <td>T1</td> <td>Transformer, Lp=550µH Np/Na=150/35</td> <td>EE808</td> <td>-</td>	3	T1	Transformer, Lp=550µH Np/Na=150/35	EE808	-
5 0.2 MosFET N-CH 60V 13mA SOT-23 2N7002 Fainchild 6 0.3 MosFET N-CH 60V 0.3A TO-92 FON 1N60C Fainchild 7 BR1 Bridge Rectifiers, 0.5A, 600V, SOIC-4 MB6S Fainchild 8 ZD1, ZD2 Diode, Zener, 18V, 500mW, SOD-123 MM524889 Fainchild 9 ZD3 Diode, Zener, 18V, 500mW, SOD-123 MM524889 Fainchild 10 D1, D2 Diode, fast redifier, 1A, 400V, SMA ES1G Fainchild 11 D3 Diode, ZonnA, 200V, SOT-23 MMB105 Fainchild 12 D4 PVF Biolar Transistor 12V 3A CPH3 CPH3106 On semiconductor 13 F1 Fuse, chip, 2A, AC/DC/25V, 1206 GRM31CR72A25KA73L Rubycon 14 C1 Capacitor Ceramic 10/F 25V 0603 - - - 15 C2 Capacitor Ceramic 10/IF 55V 0603 - - - 18 C5 Capacitor Ceramic 10/IF 55V 0603 - - - 19 C6 Capacitor Ceramic 10/IF	4	Q1	MosFET N-CH 600V 2.8A I-PAK	FQU5N60C	Fairchild
603MosFET N-CH 600V 0.3A TO-92FQN 1N60CFairchild7BR1Bridge Rectifiers, 0.5A, 600V, SOD-42MBSSPairchild8ZD1, ZD2Diode, Zener, 18V, 500mV, SOD-123MMSZ4689Fairchild10D1.102Diode, Garer, 5.V, 500mV, SOD-123MMSD1405Fairchild11D3Diode, 20mA, 200V, SOT-23MMBD1405Fairchild12D4PNP Biolar Transitors 12V 3A CPH3CPH3106On semiconductor13F1Fuse, chip, 2A, ACIDC125V, 12083410.0035.01Schurter Inc14C1Capacitor Caramic 4.VJ F3 SV 0603On Semiconductor15C2Capacitor Caramic 4.VJ F3 SV 0603IncInc16C3Capacitor Caramic 4.VJ F3 SV 0603IncInc17C4, C7Capacitor Caramic 4.VJ F3 SV 0603IncInc.18C5Capacitor Caramic 4.VJ F3 SV 0603IncInc.19C6Capacitor Caramic 4.VJ F3 SV 0603IncInc.20R1Resistor, chip, 240KQ, 110W, 0603IncInc.21R2, R11Resistor, chip, 240KQ, 110W, 0603Inc.Inc.22R3Resistor, chip, 240KQ, 110W, 0603Inc.Inc.23R4Resistor, chip, 100K, 110W, 0603Inc.Inc.24R5Resistor, chip, 100K, 110W, 0603Inc.Inc.25R6Resistor, chip, 30K, 110W, 0603Inc.Inc.26R1Resistor, chip, 30K, 110W, 0603Inc.Inc.	5	Q2	MosFET N-CH 60V 115mA SOT-23	2N7002	Fairchild
7 8R1 Bridge Rectifiers, 0.5A, 600V, SOIC-4 MB6S Fairchild 8 ZD1, ZD2 Diode, Zener, 18V, 500mW, SOD-123 MMSZ26488 Fairchild 9 ZD3 Diode, Zener, 18V, 500mW, SOD-123 MMSZ4689 Fairchild 10 D1, D2 Diode, Safer, 18V, 500mW, SOD-123 MMBD1405 Fairchild 11 D3 Diode, Safer, 41F, 400V, SMA ESIG Orsemiconductor 12 D4 PNP BipOar Transistor 12V 3A CPH3 CPH3106 Onsemiconductor 13 F1 Fuse, chip, 2A, AC/DC125V, 1206 3410.0035.01 Schurter Inc 14 C1 Capacitor Caramic 12, 2µF 100V 460.5 × 11.0 20LLERSPREFC839 Rubycon 15 C2 Capacitor Caramic 10, µF 55V 0603 Immata Immata 16 C3 Capacitor Caramic 0.1µF 50V 0603 Immata Immata 17 C4, C7 Capacitor Caramic 0.1µF 50V 0603 Immata Immata 18 R5 Resistor, chip, 100A, 110W, 0603 Immata Immata 19 R2, R11 Resistor,	6	Q3	MosFET N-CH 600V 0.3A TO-92	FQN1N60C	Fairchild
8 ZD1, ZD2 Diode, Zener, 18V, S00mW, SOD-123 MMSZ5248B Fairchild 9 ZD3 Diode, Zener, 5.1V, S00mW, SOD-123 MMSZ4689 Fairchild 10 D1, D2 Diode, Conna, 200V, SOT-23 MMBD1405 Fairchild 11 D3 Diode, Conna, 200V, SOT-23 MMBD1405 Fairchild 12 D4 PNP Bipolar Transistor 12V 3A CPH3 CPH3106 On semiconductor 13 F1 Fuse, chip, 2A, AC/DC125V, 1206 3410.0035.01 Schurter Inc 14 C1 Capacitor Caramic 2.2µF 100V 4204 GRM31CR72A2SKA731 murata 15 C2 Capacitor Caramic 0.1µF 50V 0603 Inc Inc 16 C3 Capacitor Caramic 0.1µF 50V 0603 Inc Inc 17 C4, C7 Capacitor Caramic 0.1µF 50V 0603 Inc Inc 18 C5 Capacitor Caramic 0.1µF 50V 0603 Inc Inc 19 C6 Capacitor Caramic 0.1µF 50V 0603 Inc Inc 21 R2, R11 Resistor, chip, 100A, 1/10W, 0603 Inc	7	BR1	Bridge Rectifiers, 0.5A, 600V, SOIC-4	MB6S	Fairchild
9 ZD3 Diode, Zener, 5.1V, 500mW, SDD-123 MMSZ4889 Fairchild 10 D1, D2 Diode, Zener, 5.1V, 500mW, SDD-123 MMBD1405 Fairchild 11 D3 Diode, 200mA, 200V, SOT-23 MMBD1405 Fairchild 12 D4 PMP Biolar Transistor 12V 3A CPH3 CMP1306 On semiconductor 13 F1 Fuse, chip, 2A, AC/DC125V, 1206 3410.0035.01 Schurter Inc 14 C1 Capacitor, Caramic 2.2µF 100V 1206 GRM31CR72A2SFA73. murata 15 C2 Capacitor Caramic 0.1µF 50V 0603 - - - 16 C3 Capacitor Caramic 0.1µF 50V 0603 - - - 17 C4, C7 Capacitor Caramic 0.1µF 50V 0603 - - - 18 C5 Capacitor Caramic 0.1µF 50V 0603 - - - 19 C6 Capacitor Caramic 0.1µF 50V 0603 - - - 21 R2, R11 Resistor, chip, 240AC, 1/10W, 0603 - - - 22 R	8	ZD1, ZD2	Diode, Zener, 18V, 500mW, SOD-123	MMSZ5248B	Fairchild
10D1,D2Diode, 18trectifier, 1A, 400V, SMAES1GFairchild11D3Diode, 200M, 200V, SDT-23MMBD1405Fairchild12D4PNP Biplan Transistor 12V 3A CPH3CPH3106On semiconductor13F1Expec, chip, 2A, AC/OC 125V, 1206SOLUE8R2MEFC8X9Ruburer14C1Capacitor Ceramic 2.2µF 100V 1206GRM31CR72A225KA73Lmurata15C2Capacitor Ceramic 4.7µF 35V 0603GRM31CR72A225KA73Lmurata16C3Capacitor Ceramic 0.1µF 50V 0603GRM31CR72A25KA73LGRAG17C4, C7Capacitor Ceramic 0.1µF 50V 0603GRM31CR72A25KA73LGRAG19C6Capacitor Ceramic 0.1µF 50V 0603GRGR10C4, C7Capacitor Ceramic 0.1µF 50V 0603GRGR10R2, R11Resistor, chip, 240C, 1/10W, 0603GRGR12R2, R11Resistor, chip, 240C, 1/10W, 0603GRGR12R3Resistor, chip, 240C, 1/10W, 0603GRGR13R4Resistor, chip, 100C, 1/10W, 0603GRGR14R5Resistor, chip, 100C, 1/10W, 0603GRGR15R6Resistor, chip, 100C, 1/10W, 0603GRGR16R14Resistor, chip, 100C, 1/10W, 0603GRGR17R16Resistor, chip, 100C, 1/10W, 0603GRGR18R16Resistor, chip, 100C, 1/10W, 0603GRGR19R16Resistor, chip, 100C, 1/10W, 0603GRGR </td <td>9</td> <td>ZD3</td> <td>Diode, Zener, 5.1V, 500mW, SOD-123</td> <td>MMSZ4689</td> <td>Fairchild</td>	9	ZD3	Diode, Zener, 5.1V, 500mW, SOD-123	MMSZ4689	Fairchild
11D3Diode, 200MA, 200V, SOT-23MMBD1405Pinchid12D4PNP Bjolar Transistor 12V 3A CPH3CPH3106On semiconductor13F1Fuse, chip, 2A, AC/DC12SV, 120A2411.003S01Schuren13C1Capacitor, aluminum electrolytic, 8.2 µF 200V \op 8.0 × 11.0200LLERRZMEFC8APRubycon16C3Capacitor Ceramic 2.2 µF 100V 1206GRM31CR72A225KA73Lmurata17C4, C7Capacitor Ceramic 10.µF 25V 0603GRM31CR72A225KA73Lmurata18C5Capacitor Ceramic 0.0 µF 50V 0603GRM31CR72A225KA73Lmurata19C6Capacitor Ceramic 0.0 µF 50V 0603GRM31CR72A225KA73LMICA20R1Resistor, chip, 240KQ, 110W, 0603GRM31CR72A225KA73LMica21R2, R11Resistor, chip, 240KQ, 110W, 0603GRM31CR72A225KA73LMica22R3Resistor, chip, 240KQ, 110W, 0603GRM31CR72A225KA73LMica23R4Resistor, chip, 240KQ, 110W, 0603GRM31CR72A225KA73LMica24R4Resistor, chip, 240KQ, 110W, 0603GRM31CR72A25KA73LMica25R6Resistor, chip, 100KQ, 110W, 0603GRM31CR72A25KA73LMica26R7Resistor, chip, 100KQ, 110W, 0603GRM31CR72A25KA73LMica27R4Resistor, chip, 30KQ, 110W, 0603GRM31CR32GRM31CR3228R10Resistor, chip, 30KQ, 110W, 0603GRM31CR32GRM31CR3229R14Resistor, chip, 30KQ, 110W, 0603GRM31CR32GRM31CR32<	10	D1, D2	Diode, fast rectifier, 1A, 400V, SMA	ES1G	Fairchild
12D4PNP Biplar Transistor 12V 3A CPH3CPH3106On semiconductor13F1 10Fuse, chip, 2A, AC/OC 22V, 12063410.003.01Schurter Inc.14C1Capacitor carumi 2.2µF 100V 1206200LLE8R2MEFC8X9murata15C2Capacitor Caramic 2.2µF 100V 1206GRM31CR72A2E5KA73Lmurata16C3Capacitor Caramic 1.2µF 50V 060317C4,C7Capacitor Caramic 0.1µF 50V 060318C5Capacitor Caramic 0.1µF 50V 060319C6Capacitor Caramic 0.1µF 50V 060320R1Resistor, chip, 240A, 1/10W, 060321R2, R11Resistor, chip, 240A, 1/10W, 060322R3Resistor, chip, 240A, 1/10W, 060323R4Resistor, chip, 240A, 1/10W, 060324R5Resistor, chip, 240A, 1/10W, 060325R4Resistor, chip, 100A, 1/10W, 060326R7Resistor, chip, 100A, 1/10W, 060327R4Resistor, chip, 340A, 1/10W, 060328R10Resistor, chip, 340A, 1/10W, 060329R10Resistor, chip, 340A, 1/10W, 060329R10Resistor, chip, 340A, 1/10W, 060329R10 <t< td=""><td>11</td><td>D3</td><td>Diode, 200mA, 200V, SOT-23</td><td>MMBD1405</td><td>Fairchild</td></t<>	11	D3	Diode, 200mA, 200V, SOT-23	MMBD1405	Fairchild
13 F1 Fuse, chip, 2A, AC/DC125V, 1206 3410.0035.01 Schutter Inc 14 C1 Capacitor, aluminum electrolytic, 8.2µF 200V \$8.0 × 11.0 200LLE8R2MEFC8X9 Rubycon 15 C2 Capacitor Ceramic 2.2µF 100V 1206 GRM31CR72A225KA73L murata 16 C3 Capacitor Ceramic 0.1µF 50V 0603 - - - 17 C4, C7 Capacitor Ceramic 0.1µF 50V 0603 - - - - 18 C5 Capacitor Ceramic 0.1µF 50V 0603 - - - - 19 C6 Capacitor Ceramic 0.1µF 50V 0603 - - - - 20 R1 Resistor, chip, 240K0, 1/10W, 0603 - - - - 21 R2, R11 Resistor, chip, 240K0, 1/10W, 0603 - - - - 22 R3 Resistor, chip, 240K0, 1/10W, 0603 - - - - 23 R4 Resistor, chip, 100A, 1/10W, 0603 - - - - 24	12	D4	PNP Bipolar Transistor 12V 3A CPH3	CPH3106	On semiconductor
114C1Capacitor, aluminum electrolytic, 8.2.µF 200V 48.0 × 11.0200LLE8R2MEFC8X9Rubycon115C2Capacitor Ceramie, 2.2.µF 100V 1206GRM31CR72A225KA73Lmurata116C3Capacitor Ceramie, 1.7.µF 35V 0603CCC117C4, C7Capacitor Ceramie, 0.1.µF 50V 0603GGC118C6Capacitor Ceramie, 0.1.µF 50V 0603GGC120R1Resistor, chip, 240KQ, 1/10W, 0603GGG121R2, R11Resistor, chip, 240KQ, 1/10W, 0603GGG123R4Resistor, chip, 240KQ, 1/10W, 0603GGG124R5Resistor, chip, 240KQ, 1/10W, 0603GGG125R6Resistor, chip, 200KD 14W, 1206GGG126R7Resistor, chip, 200KD 14W, 1206GGG127R8Resistor, chip, 100K, 1/10W, 0603GGG128R9Resistor, chip, 100K, 1/10W, 0603GGG129R10Resistor, chip, 30KD, 1/10W, 0603GGG129R14Resistor, chip, 30KD, 1/10W, 0603GGG130R15Resistor, chip, 30KD, 1/10W, 0603GGG131Resistor, chip, 30KD, 1/10W, 0603GGGG131Resistor, chip, 30KD, 1/10W, 0603GGGG131Resistor, chip, 30KD, 1/10W, 0603GGGG<	13	F1	Fuse, chip, 2A, AC/DC125V, 1206	3410.0035.01	Schurter Inc
15 C2 Capacitor Ceramic 2.2 μF 100V 1206 GRM31CR72A225KA73L murala 16 C3 Capacitor Ceramic 4.7 μF 35V 0603 - - 17 C4, C7 Capacitor Ceramic 10 μF 25V 0603 - - 18 C5 Capacitor Ceramic 0.1 μF 50V 0603 - - 19 C6 Capacitor Ceramic 0.1 μF 50V 0603 - - 20 R1 Resistor, winding 100 3W 45% - - 21 R2, R11 Resistor, chip, 240A, 1/10W, 0603 - - 22 R3 Resistor, chip, 24A0, 1/10W, 0603 - - 24 R5 Resistor, chip, 24A0, 1/10W, 0603 - - 25 R6 Resistor, chip, 10A0, 1/10W, 0603 - - 26 R7 Resistor, chip, 10A0, 1/10W, 0603 - - 27 R8 Resistor, chip, 10A0, 1/10W, 0603 - - 28 R9 Resistor, chip, 3A0, 1/10W, 0603 - - 30 R12 Resistor, chip, 3A0, 1/10W, 0603	14	C1	Capacitor, aluminum electrolytic, 8.2µF 200V	200LLE8R2MEFC8X9	Rubycon
16 C3 Capacitor Ceramic 4.7μ S5V 0603 - 17 C4, C7 Capacitor Ceramic 0.01μ F 50V 0603 - - 18 C5 Capacitor Ceramic 0.01μ F 50V 0603 - - 19 C6 Capacitor Ceramic 0.1μ F 50V 0603 - - 20 R1 Resistor, winding 10.0 3W ±5% - - 21 R2, R11 Resistor, chip, 240kQ, 1/10W, 0603 - - 22 R3 Resistor, chip, 240kQ, 1/10W, 0603 - - 23 R4 Resistor, chip, 200kQ 1/4W, 1206 - - 24 R5 Resistor, chip, 200kQ 1/4W, 1206 - - 25 R6 Resistor, chip, 200kQ 1/4W, 1206 - - 26 R7 Resistor, chip, 100K, 1/10W, 0603 - - 27 R8 Resistor, chip, 100K, 1/10W, 0603 - - 28 R9 Resistor, chip, 30K, 1/10W, 0603 - - 30 R12 Resistor, chip, 30K, 1/10W, 0603 - - <td>15</td> <td>C2</td> <td>Capacitor Ceramic 2.2µF 100V 1206</td> <td>GRM31CR72A225KA73L</td> <td>murata</td>	15	C2	Capacitor Ceramic 2.2µF 100V 1206	GRM31CR72A225KA73L	murata
17 C4, C7 Capacitor Ceramic 10µF 25V 0603 - - 18 C5 Capacitor Ceramic 0.01µF 50V 0603 - - 19 C6 Capacitor Ceramic 0.1µF 50V 0603 - - 20 R1 Resistor, winding 10Ω 3W 45% - - 21 R2, R11 Resistor, chip, 240KΩ, 1/10W, 0603 - - 22 R3 Resistor, chip, 10KΩ, 1/10W, 0603 - - 23 R4 Resistor, chip, 240K, 1/10W, 0603 - - 24 R5 Resistor, chip, 240K, 1/10W, 0603 - - 24 R5 Resistor, chip, 200K, 1/4W, 1206 - - 25 R6 Resistor, chip, 100K, 1/10W, 0603 - - 26 R7 Resistor, chip, 100K, 1/10W, 0603 - - 29 R10 Resistor, chip, 30K, 1/10W, 0603 - - 30 R12 Resistor, chip, 3.0K, 1/10W, 0603 - - 31 R13 Resistor, chip, 3.0K, 1/10W, 0603 - <td>16</td> <td>C3</td> <td>Capacitor Ceramic 4.7µF 35V 0603</td> <td>-</td> <td>-</td>	16	C3	Capacitor Ceramic 4.7µF 35V 0603	-	-
18 C5 Capacitor Ceramic 0.01µF 50V 0603 - - 19 C6 Capacitor Ceramic 0.1µF 50V 0603 - - 20 R1 Resistor, winding 100 3W ±5% - - 21 R2, R11 Resistor, chip, 2040, 1/10W, 0603 - - 22 R3 Resistor, chip, 10k0, 1/10W, 0603 - - 23 R4 Resistor, chip, 2040, 1/10W, 0603 - - 24 R5 Resistor, chip, 2040, 1/10W, 0603 - - 25 R6 Resistor, chip, 2040, 1/10W, 0603 - - 26 R7 Resistor, chip, 100, 1/10W, 0603 - - 27 R8 Resistor, chip, 100, 1/10W, 0603 - - 28 R9 Resistor, chip, 30k0, 1/10W, 0603 - - 30 R12 Resistor, chip, 30k0, 1/10W, 0603 - - 31 R13 Resistor, chip, 30k0, 1/10W, 0603 - - 33 R14 Resistor, chip, 30k0, 1/10W, 0603 -	17	C4, C7	Capacitor Ceramic 10µF 25V 0603	-	-
19 C6 Capacitor Ceramic 0.1µF 50V 0603 - - 20 R1 Resistor, winding 10Ω 3W ±5% - - 21 R2, R11 Resistor, chip, 240kΩ, 1/10W, 0603 - - 22 R3 Resistor, chip, 240kΩ, 1/10W, 0603 - - 23 R4 Resistor, chip, 2kΩ, 1/4W, 1206 - - 24 R5 Resistor, chip, 200Ω 1/4W, 1206 - - 25 R6 Resistor, chip, 200Ω 1/4W, 1206 - - 25 R6 Resistor, chip, 200Ω 1/4W, 1206 - - 26 R7 Resistor, chip, 200Ω 1/4W, 1206 - - 27 R8 Resistor, chip, 200Ω 1/4W, 0603 - - 28 R9 Resistor, chip, 30Ω, 1/10W, 0603 - - - 29 R10 Resistor, chip, 3.3Ω, 1/10W, 0603 - - - 31 R12 Resistor, chip, 3.3Ω, 1/10W, 0603 - - - 32 R14 Resistor,	18	C5	Capacitor Ceramic 0.01µF 50V 0603	-	-
20 R1 Resistor, winding 10Ω 3W ±5% - - 21 R2, R11 Resistor, chip, 240kΩ, 1/10W, 0603 - - 22 R3 Resistor, chip, 10kQ, 1/10W, 0603 - - 23 R4 Resistor, chip, 2kQ, 1/4W, 1206 - - 24 R5 Resistor, chip, 200kΩ 1/4W, 1206 - - 25 R6 Resistor, chip, 200kΩ 1/4W, 1206 - - 26 R7 Resistor, chip, 200kΩ 1/4W, 1206 - - 26 R7 Resistor, chip, 100kΩ, 1/10W, 0603 - - 27 R8 Resistor, chip, 100kΩ, 1/10W, 0603 - - 28 R9 Resistor, chip, 30kΩ, 1/10W, 0603 - - 29 R10 Resistor, chip, 30kΩ, 1/10W, 0603 - - 30 R12 Resistor, chip, 30kΩ, 1/10W, 0603 - - 31 R13 Resistor, chip, 150kΩ 1/4W, 1206 - - 33 R15 Resistor, chip, 150kΩ 1/4W, 1206 -	19	C6	Capacitor Ceramic 0.1µF 50V 0603	-	-
21 R2, R11 Resistor, chip, 240kΩ, 1/10W, 0603 - - 22 R3 Resistor, chip, 10kΩ, 1/10W, 0603 - - 23 R4 Resistor, chip, 2kΩ, 1/4W, 1206 - - 24 R5 Resistor, chip, 2hΩ, 1/4W, 1206 - - 25 R6 Resistor, chip, 200kΩ 1/4W, 1206 - - 26 R7 Resistor, chip, 200kΩ 1/4W, 1206 - - 26 R7 Resistor, chip, 100kΩ, 1/10W, 0603 - - 27 R8 Resistor, chip, 100kΩ, 1/10W, 0603 - - 28 R9 Resistor, chip, 30kΩ, 1/10W, 0603 - - 29 R10 Resistor, chip, 30kΩ, 1/10W, 0603 - - 30 R12 Resistor, chip, 30kΩ, 1/10W, 0603 - - 31 R13 Resistor, chip, 33Ω, 1/10W, 0603 - - 32 R14 Resistor, chip, 150kΩ 1/4W, 1206 - - 33 R15 Resistor, chip, 150kΩ 1/4W, 1206 - </td <td>20</td> <td>R1</td> <td>Resistor, winding 10Ω 3W ±5%</td> <td>-</td> <td>-</td>	20	R1	Resistor, winding 10 Ω 3W ±5%	-	-
22 R3 Resistor, chip, 1kΩ, 1/10W, 0603 - - 23 R4 Resistor, chip, 2kΩ, 1/4W, 1206 - - 24 R5 Resistor, chip, 470kΩ, 1/10W, 0603 - - 25 R6 Resistor, chip, 200kΩ 1/4W, 1206 - - 26 R7 Resistor, chip, 100kΩ, 1/10W, 0603 - - 26 R7 Resistor, chip, 100kΩ, 1/10W, 0603 - - 27 R8 Resistor, chip, 100kΩ, 1/10W, 0603 - - 28 R9 Resistor, chip, 30kΩ, 1/10W, 0603 - - 29 R10 Resistor, chip, 30kΩ, 1/10W, 0603 - - 30 R12 Resistor, chip, 30kΩ, 1/10W, 0603 - - 31 R13 Resistor, chip, 3.0L, 1/10W, 0603 - - 32 R14 Resistor, chip, 150kΩ 1/4W, 1206 - - 33 R15 Resistor, chip, 36kΩ, 1/10W, 0603 - - 34 R16 Resistor, chip, 36kΩ, 1/10W, 0603 -<	21	R2, R11	Resistor, chip, 240kΩ, 1/10W, 0603	-	-
23 R4 Resistor, chip, 2kΩ, 1/4W, 1206 - - 24 R5 Resistor, chip, 470kΩ, 1/10W, 0603 - - 25 R6 Resistor, chip, 200kΩ 1/4W, 1206 - - 26 R7 Resistor, chip, 100kΩ, 1/10W, 0603 - - 27 R8 Resistor, chip, 100kΩ, 1/10W, 0603 - - 28 R9 Resistor, chip, 10kΩ, 1/10W, 0603 - - 29 R10 Resistor, chip, 30kΩ, 1/10W, 0603 - - 30 R12 Resistor, chip, 30kΩ, 1/10W, 0603 - - 31 R13 Resistor, chip, 3.0kΩ, 1/10W, 0603 - - 32 R14 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 33 R15 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 34 R16 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 35 R17 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 36 R18 Resistor, chip, 5.3kΩ, 1/10W, 0603	22	R3	Resistor, chip, 10kΩ, 1/10W, 0603	-	-
24 R5 Resistor, chip, 470kΩ, 1/10W, 0603 - - 25 R6 Resistor, chip, 200kΩ 1/4W, 1206 - - 26 R7 Resistor, chip, 100kΩ, 1/10W, 0603 - - 27 R8 Resistor, chip, 100kΩ, 1/10W, 0603 - - 28 R9 Resistor, chip, 110kΩ, 1/10W, 0603 - - 29 R10 Resistor, chip, 30kΩ, 1/10W, 0603 - - 30 R12 Resistor, chip, 30kΩ, 1/10W, 0603 - - 31 R13 Resistor, chip, 3.0kΩ, 1/10W, 0603 - - 32 R14 Resistor, chip, 3.0kΩ, 1/10W, 0603 - - 33 R15 Resistor, chip, 4.7Ω, 1/10W, 0603 - - 34 R16 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 35 R17 Resistor, chip, 3.6kΩ, 1/10W, 0603 - - 36 R18 Resistor, chip, 3.6kΩ, 1/10W, 0603 - - 37 R19 Resistor, chip, 3.6kΩ, 1/10W, 0603	23	R4	Resistor, chip, 2kΩ, 1/4W, 1206	-	-
25 R6 Resistor, chip, 200kΩ 1/4W, 1206 - - 26 R7 Resistor, chip, 100kΩ, 1/10W, 0603 - - 27 R8 Resistor, chip, 10Ω, 1/10W, 0603 - - 28 R9 Resistor, chip, 10Ω, 1/10W, 0603 - - 28 R9 Resistor, chip, 30kΩ, 1/10W, 0603 - - 29 R10 Resistor, chip, 30kΩ, 1/10W, 0603 - - 30 R12 Resistor, chip, 30kΩ, 1/10W, 0603 - - 31 R13 Resistor, chip, 3.0kΩ, 1/10W, 0603 - - 32 R14 Resistor, chip, 4.7Ω, 1/10W, 0603 - - 33 R15 Resistor, chip, 4.7Ω, 1/10W, 0603 - - 34 R16 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 35 R17 Resistor, chip, 3.6kΩ, 1/10W, 0603 - - 36 R18 Resistor, chip, 3.6kΩ, 1/10W, 0603 - - 37 R19 Resistor, chip, 3.3kΩ, 1/10W, 0603	24	R5	Resistor, chip, 470kΩ, 1/10W, 0603	-	-
26 R7 Resistor, chip, 100kΩ, 1/10W, 0603 - - 27 R8 Resistor, chip, 10Ω, 1/10W, 0603 - - 28 R9 Resistor, chip, 110kΩ, 1/10W, 0603 - - 29 R10 Resistor, chip, 30kΩ, 1/10W, 0603 - - 30 R12 Resistor, chip, 3.0kΩ, 1/10W, 0603 - - 31 R13 Resistor, chip, 3.3Ω, 1/10W, 0603 - - 32 R14 Resistor, chip, 3.3Ω, 1/10W, 0603 - - 33 R15 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 34 R16 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 35 R17 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 36 R18 Resistor, chip, 3.3Ω, 1/10W, 0603 - - 37 R19 Resistor, chip, 3.3Ω, 1/10W, 0603 - - 38 R20 Resistor, chip, 3.3Ω, 1/10W, 0603 - - 39 R21 Resistor, chip, 1kΩ, 1/10W, 0603	25	R6	Resistorr, chip, 200kΩ 1/4W, 1206	-	-
27 R8 Resistor, chip, 10Ω, 1/10W, 0603 - - 28 R9 Resistor, chip, 110kΩ, 1/10W, 0603 - - 29 R10 Resistor, chip, 30kΩ, 1/10W, 0603 - - 30 R12 Resistor, chip, 30kΩ, 1/10W, 0603 - - 30 R12 Resistor, chip, 3.0kΩ, 1/10W, 0603 - - 31 R13 Resistor, chip, 24kΩ, 1/10W, 0603 - - 32 R14 Resistor, chip, 3.3Ω, 1/10W, 0603 - - 33 R15 Resistor, chip, 4.7Ω, 1/10W, 0603 - - 34 R16 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 35 R17 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 36 R18 Resistor, chip, 150kΩ, 1/10W, 0603 - - 37 R19 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 38 R20 Resistor, chip, 150kΩ, 1/10W, 0603 - - 39 R21 Resistor, chip, 1/10W, 0603	26	R7	Resistor, chip, 100kΩ, 1/10W, 0603	-	-
28 R9 Resistor, chip, 110kΩ, 1/10W, 0603 - - 29 R10 Resistor, chip, 30kΩ, 1/10W, 0603 - - 30 R12 Resistor, chip, 30kΩ, 1/10W, 0603 - - 30 R12 Resistor, chip, 3.0kΩ, 1/10W, 0603 - - 31 R13 Resistor, chip, 24kΩ, 1/10W, 0603 - - 32 R14 Resistor, chip, 3.3Ω, 1/10W, 0603 - - 33 R15 Resistor, chip, 4.7Ω, 1/10W, 0603 - - 34 R16 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 35 R17 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 36 R18 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 37 R19 Resistor, chip, 150kΩ, 1/10W, 0603 - - 38 R20 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 39 R21 Resistor, chip, 1kΩ, 1/10W, 0603 - -	27	R8	Resistor, chip, 10Ω, 1/10W, 0603	-	-
29 R10 Resistor, chip, 30kΩ, 1/10W, 0603 - - 30 R12 Resistor, chip, 3.0kΩ, 1/10W, 0603 - - 31 R13 Resistor, chip, 24kΩ, 1/10W, 0603 - - 32 R14 Resistor, chip, 3.3Ω, 1/10W, 0603 - - 33 R15 Resistor, chip, 4.7Ω, 1/10W, 0603 - - 34 R16 Resistor, chip, 150kΩ 1/4W, 1206 - - 35 R17 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 36 R18 Resistor, chip, 150kΩ, 1/10W, 0603 - - 37 R19 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 38 R20 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 39 R21 Resistor, chip, 1kΩ, 1/10W, 0603 - -	28	R9	Resistor, chip, 110kΩ, 1/10W, 0603	-	-
30 R12 Resistor, chip, 3.0kΩ, 1/10W, 0603 - - 31 R13 Resistor, chip, 24kΩ, 1/10W, 0603 - - 32 R14 Resistor, chip, 3.3Ω, 1/10W, 0603 - - 33 R15 Resistor, chip, 4.7Ω, 1/10W, 0603 - - 34 R16 Resistor, chip, 150kΩ 1/4W, 1206 - - 35 R17 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 36 R18 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 37 R19 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 38 R20 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 39 R21 Resistor, chip, 1kΩ, 1/10W, 0603 - -	29	R10	Resistor, chip, 30kΩ, 1/10W, 0603	-	-
31 R13 Resistor, chip, 24kΩ, 1/10W, 0603 - - 32 R14 Resistor, chip, 3.3Ω, 1/10W, 0603 - - - 33 R15 Resistor, chip, 4.7Ω, 1/10W, 0603 - - - 34 R16 Resistor, chip, 150kΩ 1/4W, 1206 - - - 35 R17 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - - 36 R18 Resistor, chip, 36kΩ, 1/10W, 0603 - - - 37 R19 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - - 38 R20 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - - 39 R21 Resistor, chip, 1kΩ, 1/10W, 0603 - - -	30	R12	Resistor, chip, 3.0kΩ, 1/10W, 0603	-	-
32 R14 Resistor, chip, 3.3Ω, 1/10W, 0603 - - 33 R15 Resistor, chip, 4.7Ω, 1/10W, 0603 - - 34 R16 Resistor, chip, 150kΩ 1/4W, 1206 - - 35 R17 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 36 R18 Resistor, chip, 36kΩ, 1/10W, 0603 - - 37 R19 Resistor, chip, 150kΩ, 1/10W, 0603 - - 38 R20 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 39 R21 Resistor, chip, 1kΩ, 1/10W, 0603 - -	31	R13	Resistor, chip, 24kΩ, 1/10W, 0603	-	-
33 R15 Resistor, chip, 4.7Ω, 1/10W, 0603 - - 34 R16 Resistor, chip, 150kΩ 1/4W, 1206 - - 35 R17 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 36 R18 Resistor, chip, 36kΩ, 1/10W, 0603 - - 37 R19 Resistor, chip, 150kΩ, 1/10W, 0603 - - 38 R20 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 39 R21 Resistor, chip, 1kΩ, 1/10W, 0603 - -	32	R14	Resistor, chip, 3.3Ω, 1/10W, 0603	-	-
34 R16 Resistorr, chip, 150kΩ 1/4W, 1206 - - 35 R17 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 36 R18 Resistor, chip, 36kΩ, 1/10W, 0603 - - 37 R19 Resistor, chip, 150kΩ, 1/10W, 0603 - - 38 R20 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 39 R21 Resistor, chip, 1kΩ, 1/10W, 0603 - -	33	R15	Resistor, chip, 4.7Ω, 1/10W, 0603	-	-
35 R17 Resistor, chip, 5.1kΩ, 1/10W, 0603 - - 36 R18 Resistor, chip, 36kΩ, 1/10W, 0603 - - 37 R19 Resistor, chip, 150kΩ, 1/10W, 0603 - - 38 R20 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 39 R21 Resistor, chip, 1kΩ, 1/10W, 0603 - -	34	R16	Resistorr, chip, 150kΩ 1/4W, 1206	-	-
36 R18 Resistor, chip, 36kΩ, 1/10W, 0603 - - 37 R19 Resistor, chip, 150kΩ, 1/10W, 0603 - - 38 R20 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 39 R21 Resistor, chip, 1kΩ, 1/10W, 0603 - -	35	R17	Resistor, chip, 5.1kΩ, 1/10W, 0603	-	-
37 R19 Resistor, chip, 150kΩ, 1/10W, 0603 - - 38 R20 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 39 R21 Resistor, chip, 1/10W, 0603 - -	36	R18	Resistor, chip, 36kΩ, 1/10W, 0603	-	-
38 R20 Resistor, chip, 3.3kΩ, 1/10W, 0603 - - 39 R21 Resistor, chip, 1kΩ, 1/10W, 0603 - -	37	R19	Resistor, chip, 150kΩ, 1/10W, 0603	-	-
39 R21 Resistor, chip, 1kΩ, 1/10W, 0603 - -	38	R20	Resistor, chip, 3.3kΩ, 1/10W, 0603	-	-
	39	R21	Resistor, chip, 1kΩ, 1/10W, 0603	-	-

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Spansion		:	Spansion,Inc	
TI		:	Texas Instruments, Inc	
Fairchild		:	Fairchild Semiconductor International, I	nc
On Semicor	nductor	:	ON Semiconductor	
Schurter Ind	c	:	Schurter Electronic Components	
Rubycon		:	Rubycon Corporation	
muRata		:	Murata Manufacturing Co., Ltd.	



Figure 13-2 5W Reference Data













14. Usage Precautions

Do not configure the IC over the maximum ratings.

If the IC is used over the maximum ratings, the LSI may be permanently damaged. It is preferable for the device to normally operate within the recommended usage conditions. Usage outside of these conditions can have an adverse effect on the reliability of the LSI.

Use the device within the recommended operating conditions.

The recommended values guarantee the normal LSI operation under the recommended operating conditions.

The electrical ratings are guaranteed when the device is used within the recommended operating conditions and under the conditions stated for each item.

Printed circuit board ground lines should be set up with consideration for common impedance.

Take appropriate measures against static electricity.

- Containers for semiconductor materials should have anti-static protection or be made of conductive material.
- After mounting, printed circuit boards should be stored and shipped in conductive bags or containers.
- Work platforms, tools, and instruments should be properly grounded.
- Working personnel should be grounded with resistance of 250 kΩ to 1 MΩ in serial between body and ground.

Do not apply negative voltages.

The use of negative voltages below - 0.3 V may make the parasitic transistor activated to the LSI, and can cause malfunctions.



15. Ordering Information

Part Number	Package	Shipping Form
MB39C605PNF-G-JNEFE1	8-pin plastic SOP (FPT-8P-M02)	Emboss
MB39C605PNF-G-JNE1		Tube

Table 15-1 Ordering Information



16. Marking Format





17. Labeling Sample





18. Recommended Conditions of Moisture Sensitivity Level

18.1 Recommended Reflow Condition

Table 18-1 Recommended Reflow Condition

ltem	Condition		
Mounting Method	IR (infrared reflow), warm air reflow		
Mounting times	2 times		
Storage period	Before opening	Please use it within 2 years after manufacture.	
	From opening to the 2nd reflow	Less than 8 days	
		Please process within 8 days after baking	
	When the storage period after opening was exceeded	(125°C±3°C, 24H+2H/-0H)	
		Baking can be performed up to 2 times.	
Storage conditions	5°C to 30°C, 70% RH or less (the lowest possible humidity)		

18.2 Reflow Profile



Figure 18-1 Reflow Profile



18.3 JEDEC Condition

Moisture Sensitivity Level3 (IPC/JEDEC J-STD-020D)

18.4 Recommended manual soldering (partial heating method)

Table 18-2 Recommended manual soldering

Item	Condition		
Storage period	Before opening	Within 2 years after manufacture	
		Within 2 years after manufacture	
	Between opening and mounting	(No need to control moisture during the storage	
		period because of the partial heating method.)	
Storage conditions	5°C to 30°C, 70%RH or less (the lowest possible humidity)		
Mounting conditions	Temperature at the tip of a soldering iron : 400°C Max.		
	Time : 5 seconds or below per pin (*1)		

*1: Make sure that the tip of a soldering iron does not come in contact with the package body.



19. Package Dimensions





Please check the latest package dimension at the following URL. http://edevice.fujitsu.com/package/jp-search/



20. Major Changes

Page	Section	Descriptions	
Revision 1.0			
-	-	Initial release	
Revision 2.0			
16	11.6 Zero Voltage Switching Function	Corrected the R _{ADJ} formula	
20	13. Application Examples	Added Application Examples	
26	15. Ordering Information	Added Shipping in Table 15-1	
		Rewrote entire document for improving the ease of understanding (the original	
-	-	intentions are remained unchanged).	









Colophon

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